

Description

GUR 4120 UHMW-PE is a linear polyolefin resin in powder form with a molecular weight of approximately 5.0 MM g.mol calculated using Margolies equation. The extremely high molecular weight of this resin yields several unique properties including superior abrasion resistance and highest impact strength of all standard grades. Outstanding properties include a low coefficient of friction that results in self-lubricating, non-stick surfaces after processing. The resin is normally processed by compression molding, ram extrusion or free sintering of porous parts.

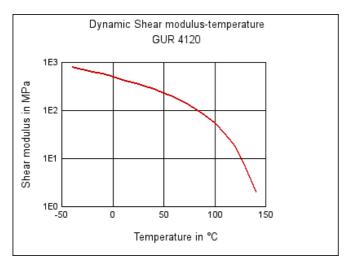
Physical properties	Value	Unit	Test Standard
Density	930	kg/m³	ISO 1183
Mass melt-flow rate (MFR) 190°C/21.6 kg		g/10 min	ISO 1133
Water absorption (23°C-sat)		%	ISO 62
Humidity absorption (23°C/50%RH)		%	ISO 62
Elongational Stress F (150/10)	0.22	MPa	ISO 11542-2
Intrinsic viscosity	2100	ml/g	ISO 1628-3
Viscosity number	2400	cm³/g	ISO 307, 1157, 1628
Mechanical properties	Value	Unit	Test Standard
Tensile modulus (1mm/min)	720	MPa	ISO 527-2/1A
Tensile stress at yield (50mm/min)	17	MPa	ISO 527-2/1A
Tensile strain at yield (50mm/min)	20	%	ISO 527-2/1A
Nominal strain at break (50mm/min)	>50	%	ISO 527-2/1A
Tensile creep modulus (1h)	460	MPa	ISO 899-1
Tensile creep modulus (1000h)	230	MPa	ISO 899-1
Charpy impact strength (14° V-notch both sides)	210	kJ/m²	ISO 11542-2
Shore hardness D scale 15 sec value	60	-	ISO 868
Ball indentation hardness 30 sec value	36	N/mm²	ISO 2039-1
Wear by sandslurry method (based on GUR 4120=100)	100	-	Internal
Thermal properties	Value	Unit	Test Standard
DTUL @ 1.8 MPa	42	°C	ISO 75-1/-2
DTUL @ 0.45 MPa	65	°C	ISO 75-1/-2
Vicat softening temperature B50 (50°C/h 50N)	80	°C	ISO 306
Coeff.of linear therm. expansion (parallel)	2	E-4/°C	ISO 11359-2
Flammability @1.6mm nom. thickn.	HB	class	UL94
thickness tested (1.6)		0.0.0	
UIICKIIESS IESIEU (T.O)	1.6	mm	UL94
	1.6 0.41	mm W/(m K)	UL94 Internal
Thermal conductivity at 23°C Specific heat at 23°C		mm W/(m K) kJ/(kg-°K)	
Thermal conductivity at 23°C	0.41	W/(m K)	Internal
Thermal conductivity at 23°C Specific heat at 23°C	0.41 1.84	W/(m K) kJ/(kg-°K)	Internal Internal
Thermal conductivity at 23°C Specific heat at 23°C Electrical properties Relative permittivity - 100 Hz	0.41 1.84 Value	W/(m K) kJ/(kg-°K) Unit	Internal Internal Test Standard
Thermal conductivity at 23°C Specific heat at 23°C Electrical properties	0.41 1.84 Value 2.1	W/(m K) kJ/(kg-°K) Unit -	Internal Internal Test Standard IEC 60250
Thermal conductivity at 23°C Specific heat at 23°C Electrical properties Relative permittivity - 100 Hz Relative permittivity - 1 MHz	0.41 1.84 Value 2.1	W/(m K) kJ/(kg-°K) Unit - -	Internal Internal Test Standard IEC 60250 IEC 60250
Thermal conductivity at 23°C Specific heat at 23°C Electrical properties Relative permittivity - 100 Hz Relative permittivity - 1 MHz Dissipation factor - 100 Hz Dissipation factor - 1 MHz	0.41 1.84 Value 2.1 3 3.9	W/(m K) kJ/(kg-°K) Unit E-4	Internal Internal Test Standard IEC 60250 IEC 60250 IEC 60250 IEC 60250 IEC 60250
Thermal conductivity at 23°C Specific heat at 23°C Electrical properties Relative permittivity - 100 Hz Relative permittivity - 1 MHz Dissipation factor - 100 Hz Dissipation factor - 1 MHz Volume resistivity	0.41 1.84 Value 2.1 3 3.9	W/(m K) kJ/(kg-°K) Unit E-4 E-4	Internal Internal Test Standard IEC 60250 IEC 60250 IEC 60250 IEC 60250 IEC 60250 IEC 60093
Thermal conductivity at 23°C Specific heat at 23°C Electrical properties Relative permittivity - 100 Hz Relative permittivity - 1 MHz Dissipation factor - 100 Hz Dissipation factor - 1 MHz	0.41 1.84 Value 2.1 3 3.9 10 >1E12	W/(m K) kJ/(kg-°K) Unit E-4 E-4 Ohm*m	Internal Internal Test Standard IEC 60250 IEC 60250 IEC 60250 IEC 60250 IEC 60250

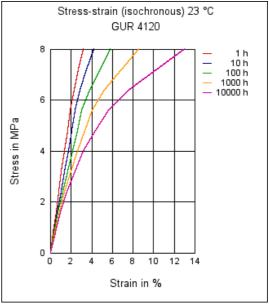


Processing properties	Value	Unit	Test Standard
Powder	Yes	-	ASTM D638
Test specimen production	Value	Unit	Test Standard
Test specimen production Comp. molding mold temperature	Value 210	Unit °C	Test Standard

Dynamic Shear modulus-temperature

Stress-strain (isochronous)

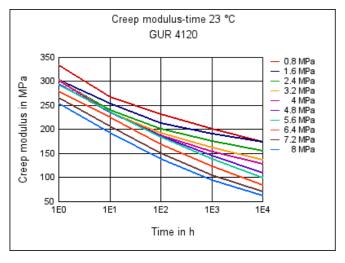


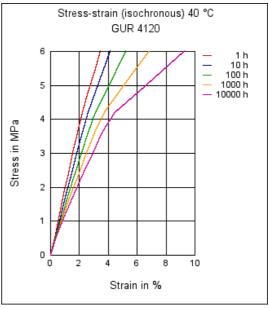




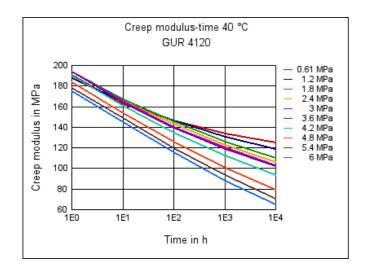
Creep modulus-time

Stress-strain (isochronous)



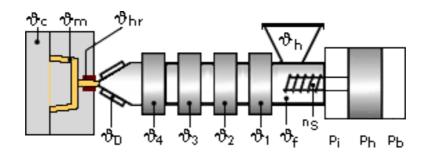


Creep modulus-time





Typical injection moulding processing conditions



Special Info:

Not for Injection Molding. For Ram Extrusion and Compression Molding only. See Ticona for processing.

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